



Product Change Notification

113634 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 113634 - 00
Change Title: Intel® Server System R1304SP2SHBN
PCN 113634-00, Product Design
Add a Mylar and a Plastic Block
Date of Publication: February 11, 2015

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

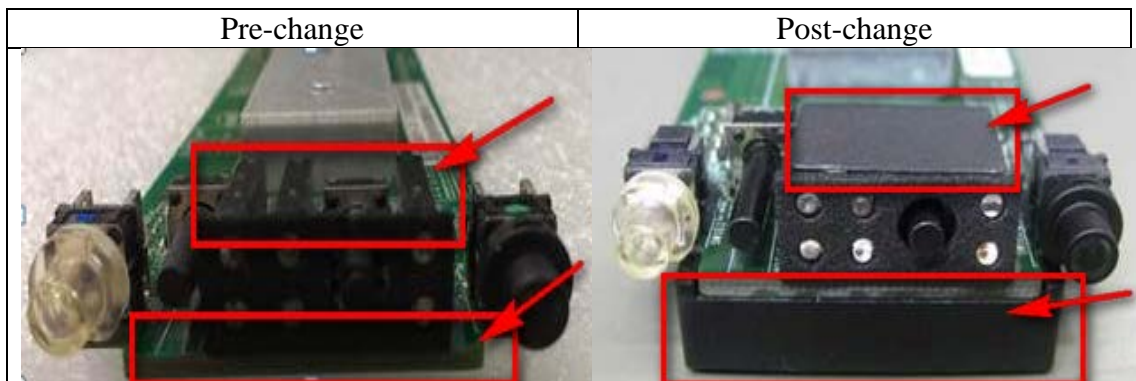
Date Customer Must be Ready to Receive Post-Conversion Material *:	February 26, 2015
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** Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server System R1304SP2SHBN:

Add a mylar on the top of the front panel board and add a plastic block for the front end under the front panel board to hold parts more securely. See the images below:



Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes. Customers may need to validate the function and feature changes once the post-change system is available.

Products Affected / Intel Ordering Codes:

CORE SKU			
Product Code	MM#	Pre Change TA	Post Change TA
R1304SP2SHBN	920591	G74419-002	G74419-003

PCN Revision History:

Date of Revision:

February 11, 2015

Revision Number:

00

Reason:

Originally Published PCN